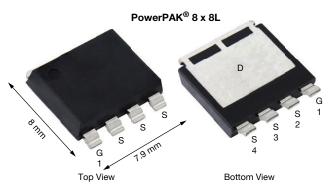


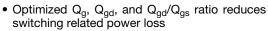
# N-Channel 60 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00092			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$	0.00115			
Q <sub>g</sub> typ. (nC)	130			
I <sub>D</sub> (A) a	437			
Configuration	Single			

#### **FEATURES**

- TrenchFET® Gen IV power MOSFET
- Fully lead (Pb)-free device

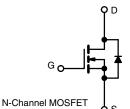




- 50 % smaller footprint than D2PAK (TO-263)
- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Synchronous rectification
- OR-ing
- Motor drive control
- Battery management
- Power supply



ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and halogen-free	SIJH602E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	60	V	
Gate-source voltage		$V_{GS}$	± 20	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		437		
	T <sub>C</sub> = 70 °C	1 . [	365		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	44 b		
	T <sub>A</sub> = 70 °C	1	37 b		
Pulsed drain current (V <sub>GS</sub> = 10 V, t = 100 μs)		I <sub>DM</sub>	700	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		303		
	T <sub>A</sub> = 25 °C	l <sub>S</sub>	3 p		
Single pulse avalanche current	1 0.1 ml l	I <sub>AS</sub>	80		
Single pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	320	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		333		
	T <sub>C</sub> = 70 °C	T . [	233	w	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.3 b	VV	
	T <sub>A</sub> =70 °C	Ī [	2.3 <sup>b</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperature) <sup>c</sup>			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient <sup>b</sup>	Steady state	R <sub>thJA</sub>	36	45	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.36	0.45	C/VV	

#### **Notes**

T<sub>C</sub> = 25 °C

Surface mounted on 1" x 1" FR4 board

Surface mounted on 1° x 1° F44 board

See solder profile (<a href="https://www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components



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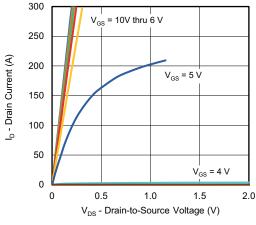
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	35	-	\//00	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-8.3	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20$	=	=	100	nA	
Zero gate voltage drain current		V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V	-	-	1		
	I <sub>DSS</sub>	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	15	μA	
Drain-source on-state resistance <sup>a</sup>	Б	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	0.00062	0.00092	Ω	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 7.5 V, I <sub>D</sub> = 20 A	-	0.0007	0.00115		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, I_D = 50 \text{ A}$	-	170	-	S	
Dynamic <sup>b</sup>					•		
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	9950	-	pF	
Output capacitance	C <sub>oss</sub>		-	2575	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	78	-		
Table also de con		$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	130	212	nC	
Total gate charge	Qg		-	95	161		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 7.5 \text{ V}, I_{D} = 20 \text{ A}$	-	45	-		
Gate-drain charge	Q <sub>gd</sub>		-	15	-		
Gate resistance	$R_g$	f = 1 MHz	0.23	1.4	2.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	22	45	-	
Rise time	t <sub>r</sub>	$\begin{split} V_{DD} = 30 \text{ V, } R_L = 3  \Omega \text{, } I_D &\cong 10 \text{ A,} \\ V_{GEN} = 10 \text{ V, } R_g = 1  \Omega \end{split}$	-	15	30		
Turn-off delay time	t <sub>d(off)</sub>		-	55	110		
Fall time	t <sub>f</sub>		-	20	40		
Turn-on delay time	t <sub>d(on)</sub>		-	30	60	ns	
Rise time	t <sub>r</sub>	$\begin{split} V_{DD} = 30 \text{ V, } R_L = 3  \Omega, I_D &\cong 10 \text{ A,} \\ V_{GEN} = 7.5 \text{ V, } R_g = 1  \Omega \end{split}$	-	20	40	-	
Turn-off delay time	t <sub>d(off)</sub>		-	50	100		
Fall time	t <sub>f</sub>		-	20	40		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	=	303	^	
Pulse diode forward current	I <sub>SM</sub>		-	-	700	A	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.73	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	105	175	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	1 40 A 31/31 400 A / T 67 30	-	170	260	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$	-	45	-	p	
Reverse recovery rise time	t <sub>b</sub>		-	60	-	ns	

#### **Notes**

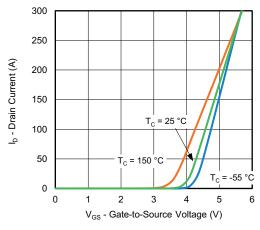
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

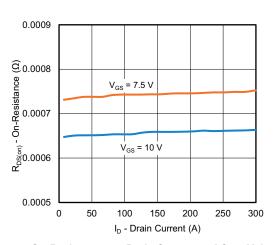




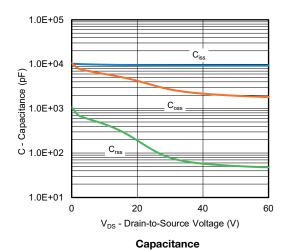


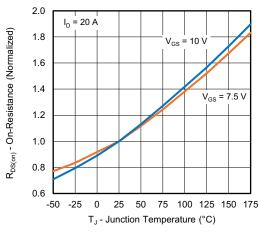


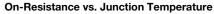
**Transfer Characteristics** 

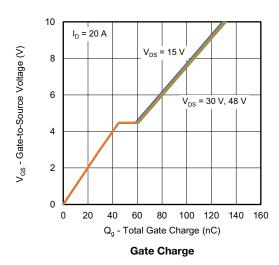


On-Resistance vs. Drain Current and Gate Voltage

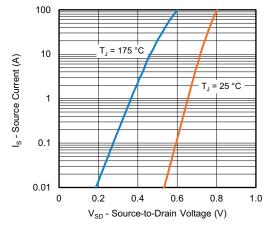




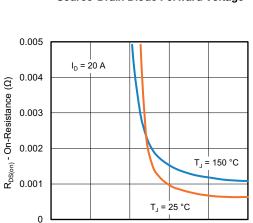








Source-Drain Diode Forward Voltage

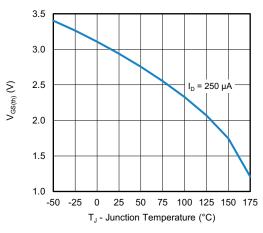


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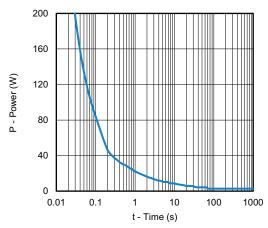
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8

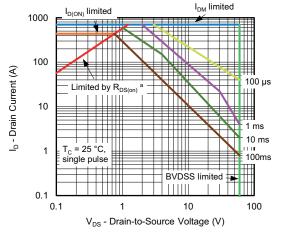
10



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient



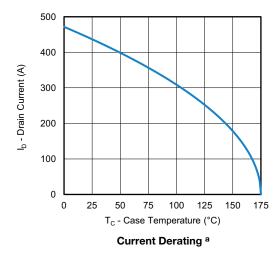
Safe Operating Area, Junction-to-Ambient

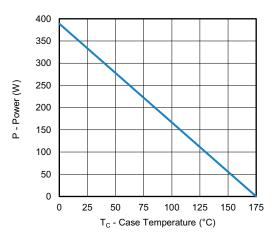
#### Note

a.  $V_{GS} > minimum V_{GS}$  at which  $R_{DS(on)}$  is specified

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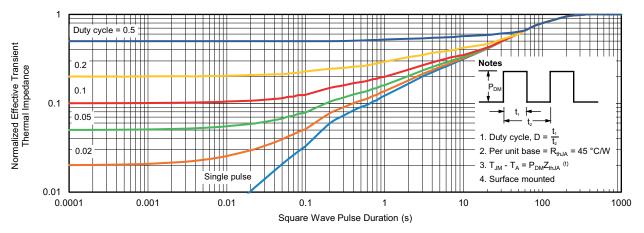


Power, Junction-to-Case

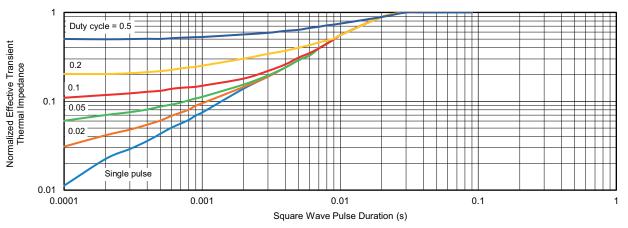
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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